

APT1608SF4C-PRV

1.6 x 0.8 mm Infrared Emitting Diode



DESCRIPTION

• SF4 Made with Gallium Aluminum Arsenide Infrared **Emitting diodes**

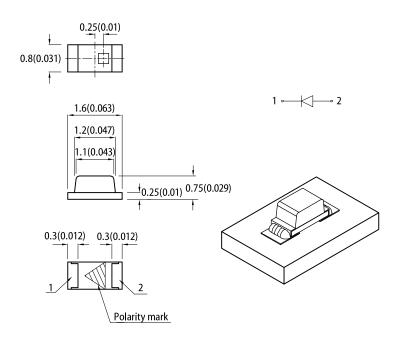
FEATURES

- 1.6 mm x 0.8 mm SMD LED, 0.75 mm thickness
- · Mechanically and spectrally matched to Phototransistor
- Package matches with photodetector AP1608P1C-P22
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

- · Infrared Illumination for cameras
- Machine vision systems
- · Surveillance systems
- · Industrial electronics
- IR data transmission
- Remote control

PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: \pm 0.1)



- Notes:

 1. All dimensions are in millimeters (inches).

 2. Tolerance is ±0.1(0.004") unless otherwise noted.

 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Po (mW/sr) @ 20mA ^[2]		Viewing Angle [1]
			Min.	Тур.	201/2
APT1608SF4C-PRV	Infrared (GaAlAs)	Water Clear	0.8	1.5	150°

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1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Radiant Intensity / luminous flux: +/-15%.

3. Radiant intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol Emitting Color Typ. Max.	Emitting Color	Value		Unit
Faranteter		Max.	Offic		
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Infrared	880	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Infrared	50	-	nm
Capacitance	С	Infrared	90	-	pF
Forward Voltage I _F = 20mA	V _F ^[1]	Infrared	1.3	1.6	V
Reverse Current (V _R = 5V)	I _R	Infrared	-	10	μА
Temperature Coefficient of Wavelength I_F = 20mA, -10 $^{\circ}$ C \leq T \leq 85 $^{\circ}$ C	TCA	Infrared	0.3	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10°C \leq T \leq 85°C	TC _V	Infrared	-1.3	-	mV/°C

Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P _D	85	mW
Reverse Voltage	V _R	5	V
Junction Temperature	Tj	125	°C
Operating Temperature	T _{op}	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
DC Forward Current	I _F	50	mA
Peak Forward Current	I _{FP} ^[1]	1200	mA
Electrostatic Discharge Threshold (HBM)	-	8000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} [2]	540	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} [2]	440	°C/W

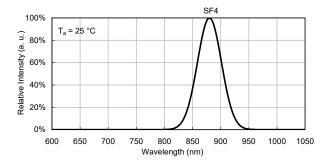
Notes:
1. 1/100 Duty Cycle, 10μ s Pulse Width.
2. $R_{\text{In Ja}}$, $R_{\text{In Ja}}$, $R_{\text{In Ja}}$ Results from mounting on PC board FR4 (pad size \geq 16 mm² per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



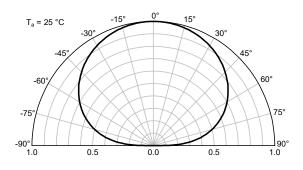


TECHNICAL DATA

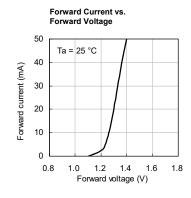
RELATIVE INTENSITY vs. WAVELENGTH

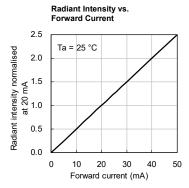


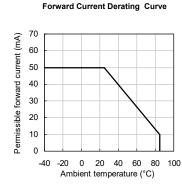
SPATIAL DISTRIBUTION

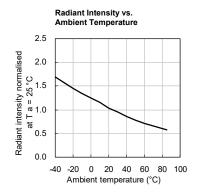


INFRARED

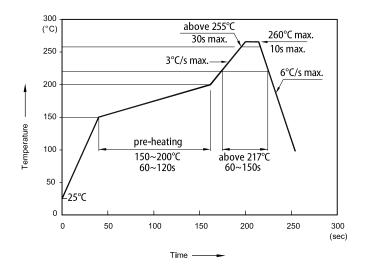








REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



Notes:

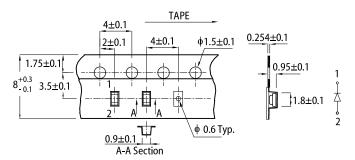
- Notes:

 1. Don't cause stress to the LEDs while it is exposed to high temperature.

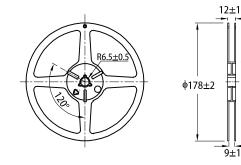
 2. The maximum number of reflow soldering passes is 2 times.

 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

TAPE SPECIFICATIONS (units:mm)



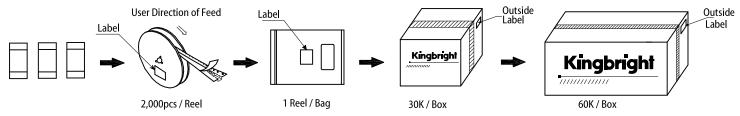
REEL DIMENSION (units: mm)

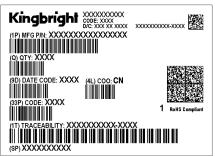


φ60±2



PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
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